

LNA-IC for 1.5GHz Band Applications

FEATURES

- Low voltage operation +2.85 V typ.
- Low current consumption
- High gain 19 dB typ. fRX = 1 575 MHz
- Low noise figure 0.86 dB typ. fRX = 1 575 MHz
- Low distortion +4 dBm typ. fRX = 1 575 MHz
- (IIP3 +10 MHz offset)
- Small package5 pin Plastic Small Surface Mount Package
 (SMINI Type)

9.5 mA typ.

DESCRIPTION

AN26014A is LNA-IC for 1.5 GHz Band Applications. Realizing high performance by using 0.18 μ m SiGeC Bi-CMOS process(f_T = 90 GHz, f_{max} = 140 GHz). Sleep mode is available, controlled by integrated CMOS logic circuit.

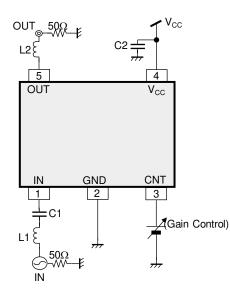
Achieving miniaturization by using small size package.

APPLICATIONS

•GPS

SIMPLIFIED APPLICATION

TOP VIEW



Components	Size Value		Part Number	Vendor
L1	0603	3.0 nH	LQP03T3N0B04	Murata
L2	0603	5.6 nH	LQP03T5N6H04	Murata
C1	0603	1 000 pF	GRM033B11C102KD01	Murata
C2	0603	0.1 uF	GRM33B30J104KE18	Murata

Notes) This application circuit is an example. The operation of mass production set is not guaranteed. You should perform enough evaluation and verification on the design of mass production set. You are fully responsible for the incorporation of the above application circuit and information in the design of your equipment.

ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Rating	Unit	Note
Supply voltage	V _{cc}	3.6	V	*1
Supply current	I _{cc}	18	mA	_
Operating ambient temperature	T _{opr}	-20 to 70	°C	*2
Operating junction temperature	T _j	-40 to +125	°C	*2
Storage temperature	T _{stg}	-55 to +125	°C	*2
	IN (Pin No.1)	_	V	*3
Input Voltage Range	CNT (Pin No.3)	-0.3 to (V _{CC} + 0.3)	V	*4
	OUT (Pin No.5)	-0.3 to (V _{CC} + 0.3)	V	*4
	HBM (Human Body Model)	2	kV	_
ESD	MM (Machine Model)	200	V	_

Notes). This product may sustain permanent damage if subjected to conditions higher than the above stated absolute maximum rating. This rating is the maximum rating and device operating at this range is not guaranteeable as it is higher than our stated recommended operating range.

When subjected under the absolute maximum rating for a long time, the reliability of the product may be affected.

*1:The values under the condition not exceeding the above absolute maximum ratings and the power dissipation.

*2:Except for the power dissipation, operating ambient temperature, and storage temperature, all ratings are for Ta = 25°C. *3:RF signal input pin. Do not apply DC current.

*4:(Vcc + 0.3) V must not be exceeded 3.6 V

POWER DISSIPATION RATING

PACKAGE	θ_{A}	PD (Ta=25 °C)	PD (Ta=70 °C)
SSMINI-5DC	833.3°C/W	0.12W	0.06W

Note). For the actual usage, please refer to the PD-Ta characteristics diagram in the package specification, supply voltage, load and ambient temperature conditions to ensure that there is enough margin follow the power and the thermal design does not exceed the allowable value.



CAUTION

Although this has limited built-in ESD protection circuit, but permanent damage may occur on it. Therefore, proper ESD precautions are recommended to avoid electrostatic damage to the MOS gates

RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	Min.	Тур.	Max.	Unit	Note
Supply voltage range	V _{cc}	2.70	2.85	3.0	V	*1

Note) *1 : The values under the condition not exceeding the above absolute maximum ratings and the power dissipation.

ELECRTRICAL CHARACTERISTICS

Note) Vcc = 2.85 V, Ta = $25^{\circ}C\pm 2^{\circ}C$ unless otherwise specified.

Devementer	Symbol	Conditions	Limits			Unit	Note		
Parameter			Min	Тур	Мах	Unit	Note		
DC electrical characteristics	C electrical characteristics								
Supply current	IccH	Vcc current at Active mode No input signal	_	9.5	13.0	mA			
Sleep current	lccS	Vcc current at Sleep mode No input signal	_	1	10	μA	—		
CNT current (On)	IcntH	CNT current at Active mode No input signal	_	5	35	μA	_		
CNT current (Sleep)	IcntL	CNT current at Sleep mode No input signal	_	0.5	10	μA			
CNT voltage (On)	VIH		2.57	2.85	_	V			
CNT voltage (Sleep)	VIL			0	0.37	V	_		

ELECRTRICAL CHARACTERISTICS (continued)

Note) Vcc = 2.85 V, Ta = 25°C±2°C, fRX = 1 575 MHz, PRX = -30 dBm, CW unless otherwise specified.

Parameter	Symbol	Conditions	Limits			Unit	Note	
Farameter	Symbol	Conditions	Min	Тур	Мах	Unit	Note	
LNA AC electrical charac	NA AC electrical characteristics							
Power Gain	PGS	f = 1 575 MHz, PRX = - 30 dBm	16.7	19.0	20.7	dB	_	
IIP3 +10 MHz offset	IIP31S	f1 = fRX + 10 MHz f2 = fRX + 20 MHz Input 2 signals (f1, f2)	0	4.0		dBm		
IIP3 –10 MHz offset	IIP32S	f1 = fRX - 10 MHz f2 = fRX - 20 MHz Input 2 signals (f1, f2)	0	4.0		dBm	_	

APPLICATION INFORMATION REFERENCE VALUES FOR DESIGN

Note) Vcc = 2.85 V

All characteristics are specified under Ta = 25°C \pm 2°C, fRX = 1575 MHz , PRX = -30 dBm , CW

Deremeter	Symbol Conditions		Reference values			Unit	Note
Parameter	Symbol	Conditions	Min	Тур	Мах	Unit	Note
NA AC electrical characteristics							
Noise Figure	NF	f = fRX		1.0	1.4	dB	*1 , *2
Reverse Isolation	ISO	f = fRX		-32	-21	dB	*1
Input Return Loss	S11	f = fRX	7	9.5		dB	*1
Output Return Loss	S22	f = fRX	10	13		dB	*1

Note) *1 : Checked by design, not production tested.

*2 : Connector & substrate loss (0.14 dB) included.

APPLICATION INFORMATION (continued) REFERENCE VALUES FOR DESIGN (continued)

Notes) Vcc = 2.7 V to 3.0 V

All characteristics are specified under Ta = -20 °C to 70 °C, fRX = 1 575 MHz, PRX = -30 dBm, CW

	Parameter		Symbol Conditions		Reference values			Note
	Farameter	Symbol	Conditions	Min	Тур	Max	Unit	Note
DC ele	ectrical characteristics							
	Supply current	IccHT	Vcc current No input signal	_	9.5	14.0	mA	*1
	Sleep current	IccST	Vcc current at Sleep mode No input signal	_	1	12	μA	*1
	CNT current (On)	IcntHT	CNT current at Active mode No input signal	_	5	40	μA	*1
	CNT current (Sleep)	IcntLT	CNT current at Sleep mode No input signal	_	0.5	12	μA	*1

Note) *1 : Checked by design, not production tested.

APPLICATION INFORMATION (continued) REFERENCE VALUES FOR DESIGN (continued)

Notes) Vcc = 2.7 V to 3.0 V

All characteristics are specified under Ta = -20° C to 70° C, fRX = 1 575 MHz, PRX = -30 dBm, CW

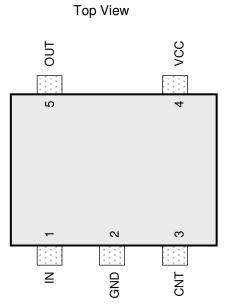
	Devementer	Cumhal	Conditions	Reference Values			Unit	Note
	Parameter	Symbol	Conditions	Min	Тур	Мах	Unit	Note
LNA	NA AC electrical characteristics							
	Power Gain	GT	f = fRX	16.0	19.0	21.5	dB	*1
	Noise Figure	NFT	f = fRX	_	1.0	1.6	dB	*1 , *2
	IIP3 +10 MHz offset	IIP31T	f1 = fRX + 10 MHz f2 = fRX + 20 MHz Input 2 signals (f1, f2)	- 1.0	4.0	_	dBm	*1
	IIP3 –10 MHz offset	IIP32T	f1 = fRX - 10 MHz f2 = fRX - 20 MHz Input 2 signals (f1, f2)	- 1.0	4.0	_	dBm	*1

Note) *1 : Checked by design, not production tested.

*2 : Connector & substrate loss (0.14 dB) included.



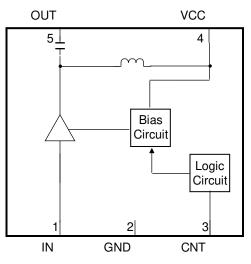
PIN CONFIGURATION



PIN FUNCTIONS

Pin No.	Pin name	Туре	Description	
1	IN	Input	RF Input	
2	GND	Ground	GND	
3	CNT	Input	CNT (Sleep mode) L: Sleep Mode H: On Mode	
4	VCC	Power Supply	V _{cc}	
5	OUT	Output	RF Output	

FUNCTIONAL BLOCK DIAGRAM



Notes) · This block diagram is for explaining functions. Part of the block diagram may be omitted, or it may be simplified.

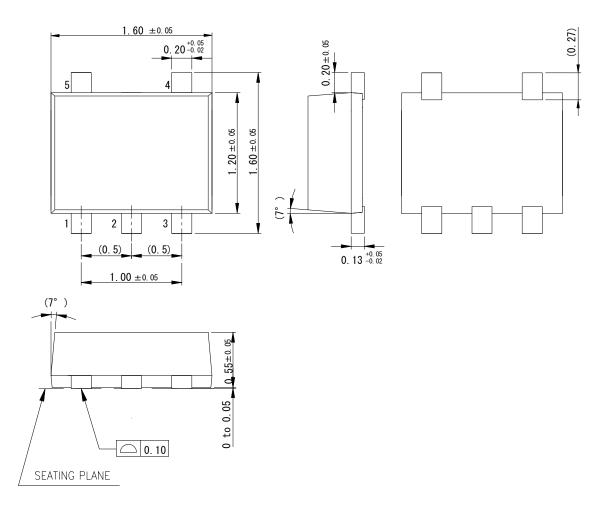




PACKAGE INFORMATION (Reference Data)

Package Code:SSMINI-5DC

Unit:mm



Body Material	Br / Sb Free Epoxy Resin				
Lead Material	: Cu Alloy				
Lead Finish Method : SnBi Plating					

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- (4) Submarine transponder
- (5) Control equipment for power plant
- (6) Disaster prevention and security device
- (7) Weapon

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USAGE NOTES

1. When designing your equipment, comply with the range of absolute maximum rating and the guaranteed operating conditions (operating power supply voltage and operating environment etc.). Especially, please be careful not to exceed the range of absolute maximum rating on the transient state, such as power-on, power-off and mode-switching. Otherwise, we will not be liable for any defect which may arise later in your equipment.

Even when the products are used within the guaranteed values, take into the consideration of incidence of break down and failure mode, possible to occur to semiconductor products. Measures on the systems such as redundant design, arresting the spread of fire or preventing glitch are recommended in order to prevent physical injury, fire, social damages, for example, by using the products.

- 2. Comply with the instructions for use in order to prevent breakdown and characteristics change due to external factors (ESD, EOS, thermal stress and mechanical stress) at the time of handling, mounting or at customer's process. When using products for which damp-proof packing is required, satisfy the conditions, such as shelf life and the elapsed time since first opening the packages.
- 3. Pay attention to the direction of LSI. When mounting it in the wrong direction onto the PCB (printed-circuitboard), it might smoke or ignite.
- 4. Pay attention in the PCB (printed-circuit-board) pattern layout in order to prevent damage due to short circuit between pins. In addition, refer to the Pin Description for the pin configuration.
- 5. Perform a visual inspection on the PCB before applying power, otherwise damage might happen due to problems such as a solder-bridge between the pins of the semiconductor device. Also, perform a full technical verification on the assembly quality, because the same damage possibly can happen due to conductive substances, such as solder ball, that adhere to the LSI during transportation.
- 6. Take notice in the use of this product that it might break or occasionally smoke when an abnormal state occurs such as output pin-VCC short (Power supply fault), output pin-GND short (Ground fault), or output-to-output-pin short (load short).

And, safety measures such as an installation of fuses are recommended because the extent of the abovementioned damage and smoke emission will depend on the current capability of the power supply.